1200V 40A Insulated Gate Bipolar Transistor
AKBK2A040WHH

Description:

Gen 2 IGBT with soft, fast recovery full current rated anti-parallel Emitter Controlled diode, providing ultra-low conduction loss . They are designed for applications such as UPS, inverters, etc.

Features:

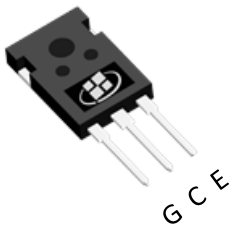
- 10μsec short circuit withstand time at T_{VJ}=175℃
- Easy paralleling capability due to positive temperature coefficient in V_{CEsat}
- Low EMI
- Low Gate Charge Q_G
- Very soft, fast recovery full current anti-parallel diode
- Maximum junction temperature T_{VJMAX}=175℃
- RoHS compliant (Note 1)
- Halogen-free (Note 1)

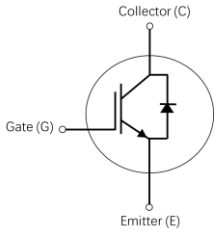
Applications:

- Industrial UPS
- Charger
- Energy Storage
- Three-phase Solar String Inverter

Key Performance Parameters:

Parameter	Value	Unit
V_{CE}	1200	V
V_{CESAT}, T_{VJ} = 25°C	1.9	V
I_C	40	A





Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKBK2A040WHH	TO247-3L	BK2A040WHH	Tube	300PCS

Notes:

1. Contact ALKAIDSEMI sales for detail information

Maximum Ratings (T_A = 25℃ unless otherwise noted)

Symbol	Parameter	Value	Units
V_{CE}	Collector-Emitter Voltage	1200	V
I_C	Collector Current - Continuous (T_C = 25℃) (Note 1)	80	A
	Collector Current - Continuous (T_C = 100℃)	40	
I_{CM}	Collector Current - Pulsed (Note 2)	160	A
I_F	Diode Forward Current, Limited by T_{VJmax} (T_C = 25℃)	80	A
	Diode Forward Current, Limited by T_{VJmax} (T_C = 100℃)	40	
I_{FM}	Diode Pulsed Current, - Pulsed (Note 2)	160	A
V_{GE}	Gate-Emitter Voltage	±20	V
	Transient Gate-Emitter Voltage (tp ⩽ 10μs, D < 0.010)	±30	
T_{SC}	Short Circuit Withstand Time V_{GE} = 15.0V, V_{CC} ⩽ 400V	10	μS
P_D	Power Dissipation (T_C = 25℃)	417	W
	Power Dissipation (T_C = 100℃)	208	W
T_J	Operating Junction Temperature Range	-40 to +175	℃
T_{STG}	Storage Temperature Range	-55 to +150	℃

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	IGBT Thermal Resistance, Junction-to-Case, Steady-State	0.36	℃/W
$R_{\theta JC}$	Diode Thermal Resistance, Junction-to-Case, Steady-State	0.45	℃/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient Steady State	40	℃/W

Notes:

1. The max collector current rating is package limited
2. Repetitive Rating: Pulse width limited by maximum junction temperature

Electrical Characteristics (T_{VJ} = 25℃ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Static Characteristics						
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	V_{GE} = 0 V, I_C = 0.5 mA	1200			V
V_{CESAT}	Collector-Emitter Saturation Voltage	V_{GE} = 15 V, I_C = 40 A	1.6	1.9	2.3	V
		V_{GE} = 15 V, I_C = 40 A, T_{VJ} = 175℃		2.9		
V_F	Diode Forward Voltage	V_{GE} = 0 V, I_F = 40 A	1.7	1.9	2.1	V
		V_{GE} = 0 V, I_F = 40 A, T_{VJ} = 175℃		1.95		
$V_{GE(TH)}$	Gate-Emitter Threshold Voltage	V_{CE} = V_{GE}, I_C = 1.5 mA	5.1	5.8	6.5	V
I_{CES}	Zero Gate Voltage Collector Current	V_{CE} = 1200 V, V_{GE} = 0 V			250	μA
		V_{CE} = 1200 V, V_{GE} = 0 V,T_{VJ} = 175℃		3000		
I_{GES}	Gate-Emitter Leakage Current	V_{GE} = ± 20 V, V = 0 V			±100	nA
G_{FS}	Transconductance	V_{GE} = 20 V, I_C = 40 A		28		S
Dynamic Characteristics						
C_{IES}	Input Capacitance	V_{CE} = 25 V, V_{GS} = 0 V, F = 1 MHz		5047		pF
C_{OES}	Output Capacitance			161		pF
C_{RES}	Reverse Transfer Capacitance			35		pF
Q_G	Total Gate Charge	V_{CC} = 960 V , I_C = 40 A, V_{GE} = 15 V		170		nC
Q_{GE}	Gate-Emitter Charge			37.5		nC
Q_{GC}	Gate-Collector Charge			68		nC
L_E	Internal Emitter Inductance			8		nH
Switching Characteristics, Inductive Load (T_{VJ} = 25℃)						
$T_{D(ON)}$	Turn On Delay Time	V_{CC} = 600 V I_C = 40 A V_{GE} = 15 V R_{Gon} = 12 Ω R_{Goff} = 12 Ω		46		nS
T_R	Rise Time			48		nS
$T_{D(OFF)}$	Turn Off Delay Time			194.4		nS
T_F	Fall Time			99		nS
E_{ON}	Turn On Energy			2.62		mJ
E_{OFF}	Turn Off Energy			1.55		mJ
E_{TOTAL}	Total Switching Energy			4.17		mJ

Drain-Source Diode Characteristics						
T_{RR}	Reverse recovery time	V_R = 600 V, I_R = 40 A, di/dt = 600 A/μS		270.8		nS
Q_{RR}	Reverse recovery charge			1.7		μC
I_{RRM}	Peak Reverse Recovery Current			19.2		A
dirr/dt	Diode Peak Rate of Fall of Reverse Recovery Current			-74.5		A/μs
Switching Characteristics, Inductive Load (T_{VJ} = 175℃)						
$T_{D(ON)}$	Turn On Delay Time	V_{CC} = 600 V I_C = 40 A V_{GE} = 15 V R_{Gon} = 12 Ω R_{Goff} = 12 Ω		45		nS
T_R	Rise Time			51		nS
$T_{D(OFF)}$	Turn Off Delay Time			223.5		nS
T_F	Fall Time			141		nS
E_{ON}	Turn On Energy			4.7		mJ
E_{OFF}	Turn Off Energy			2.3		mJ
E_{TOTAL}	Total Switching Energy			7		mJ
Drain-Source Diode Characteristics						
T_{RR}	Reverse recovery time	V_R = 600 V, I_R = 40 A, di/dt = 600 A/μS		418		nS
Q_{RR}	Reverse recovery charge			5		μC
I_{RRM}	Peak Reverse Recovery Current			30.5		A
dirr/dt	Diode Peak Rate of Fall of Reverse Recovery Current			-74		A/μs

Electrical Characteristics Diagrams

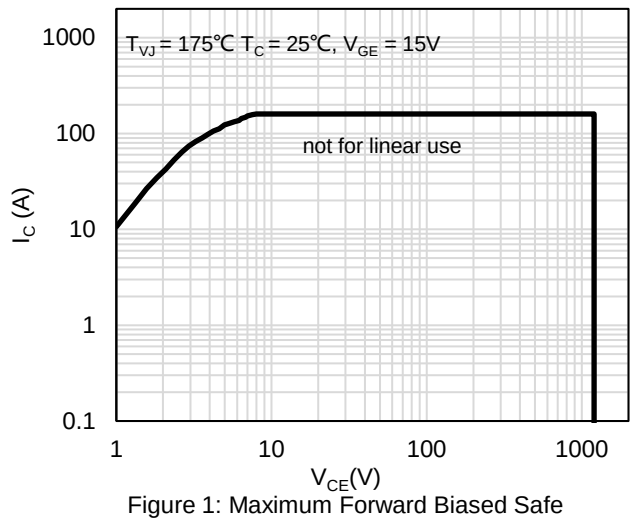


Figure 1: Maximum Forward Biased Safe Operating Area

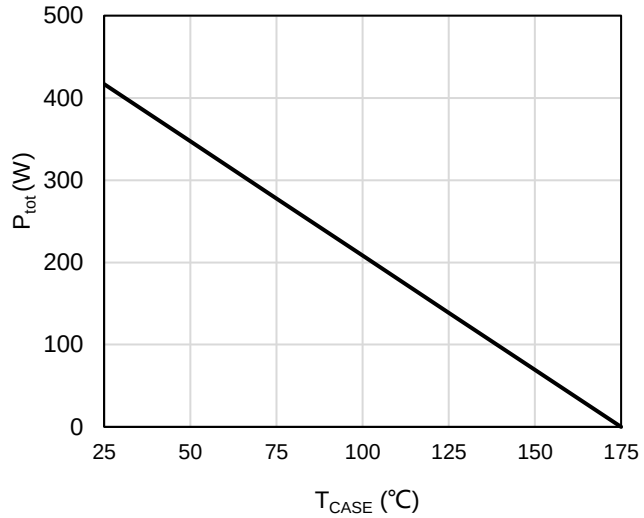


Figure 2: Power De-rating

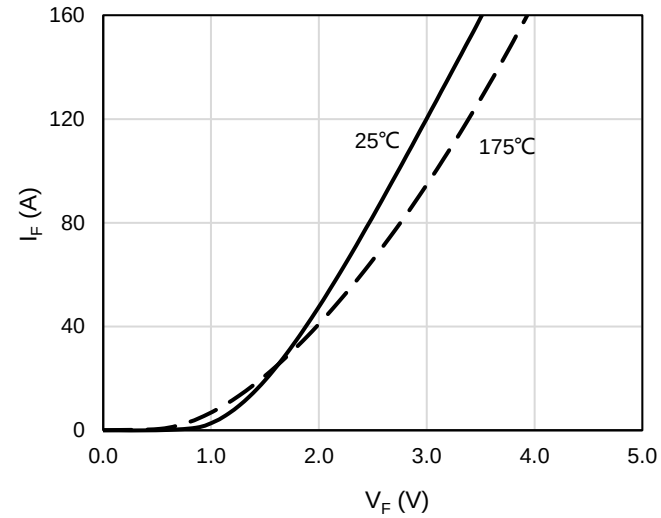


Figure 3: Diode Forward Current Characteristics

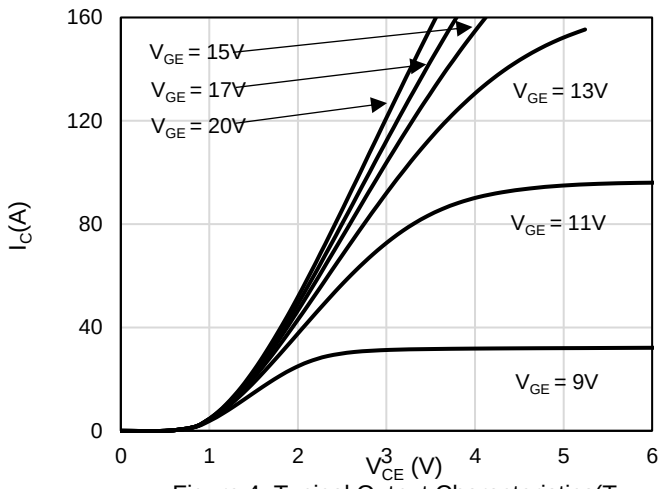


Figure 4: Typical Output Characteristics(T_{VJ} =25℃)

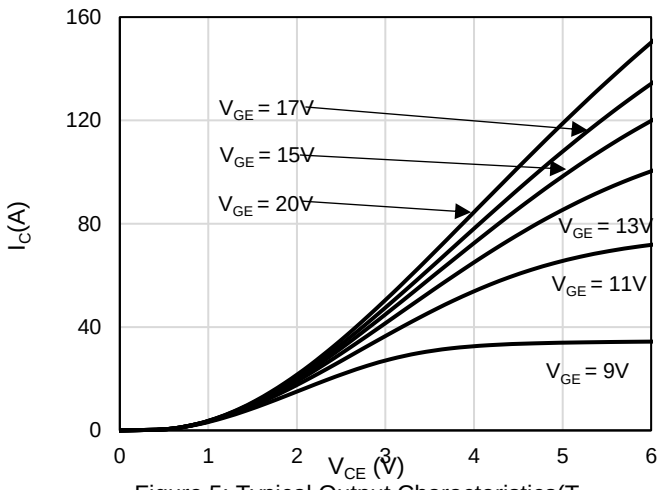


Figure 5: Typical Output Characteristics(T_{VJ} =175℃)

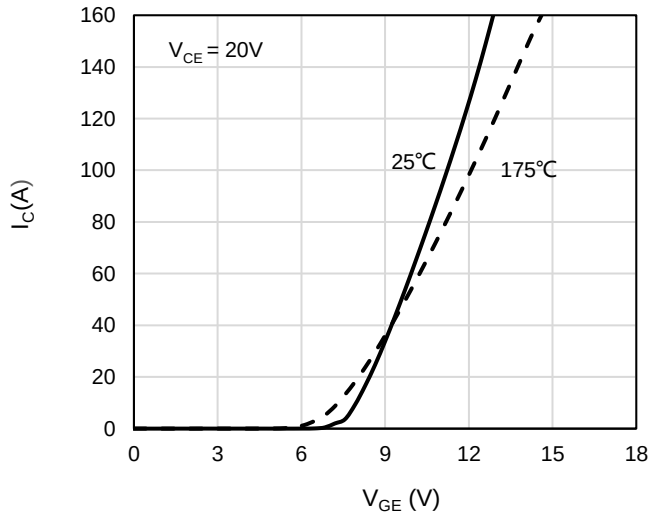


Figure 6: Transfer Characteristics

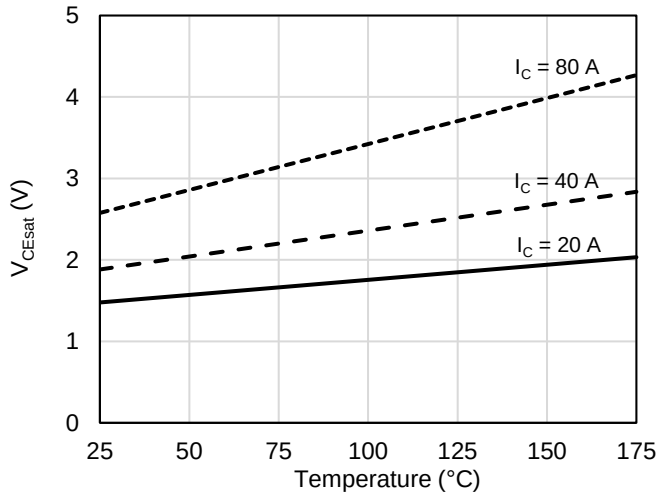


Figure 7: Collect-emitter Saturation Voltage vs. Junction Temperature

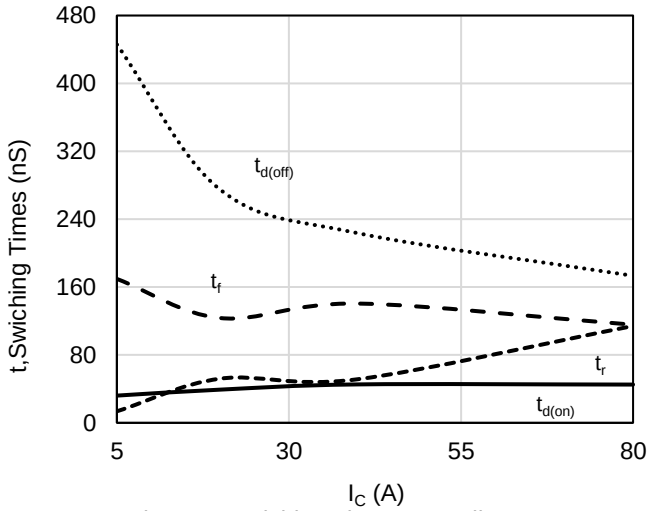


Figure 8: Swiching Times vs. Collector Current

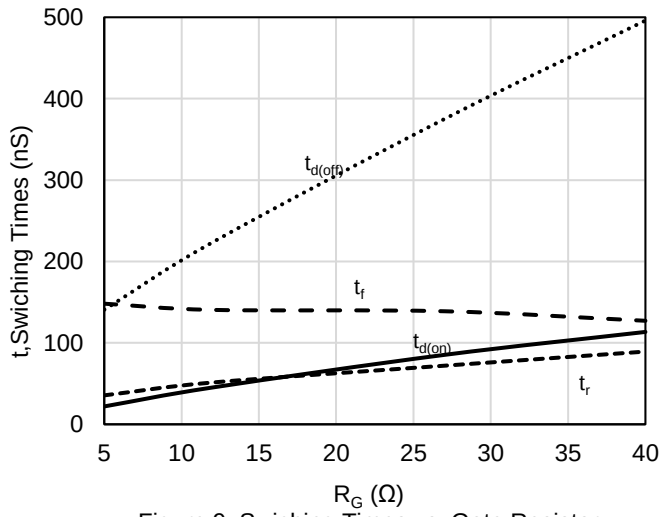


Figure 9: Swiching Times vs. Gate Resistor

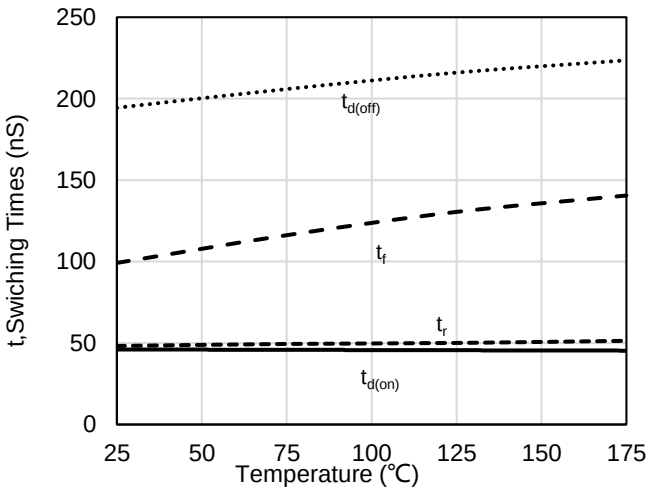


Figure 10: Swiching Times vs. Junction Temperature

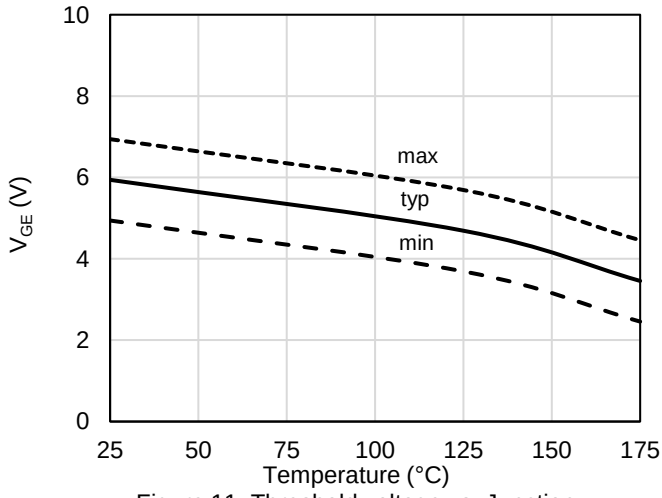


Figure 11: Threshold voltage vs. Junction Temperature

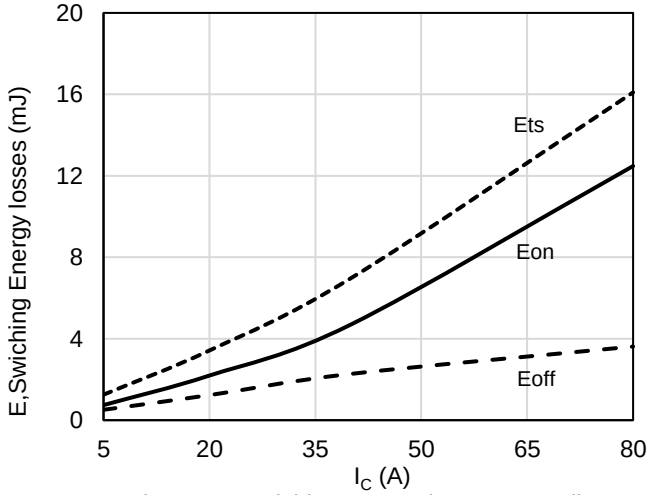


Figure 12: Swiching Energy losses vs. Collector Current

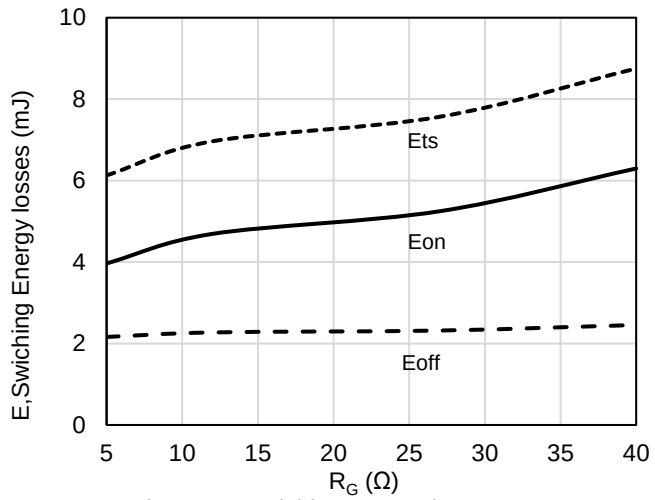


Figure 13: Swiching Energy losses vs. Gate Voltage

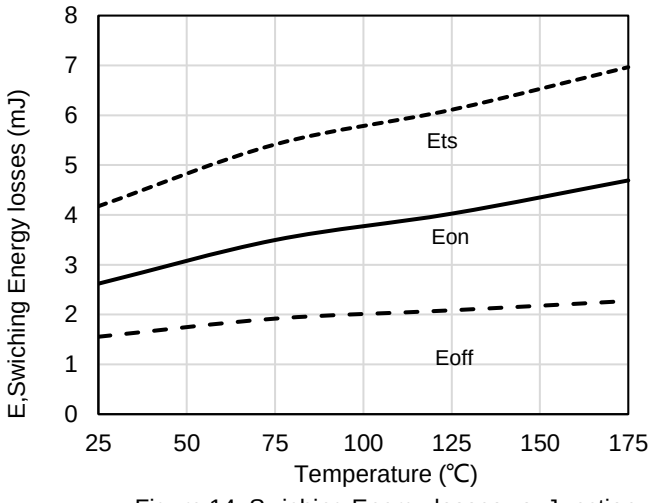


Figure 14: Swiching Energy losses vs. Junction Temperature

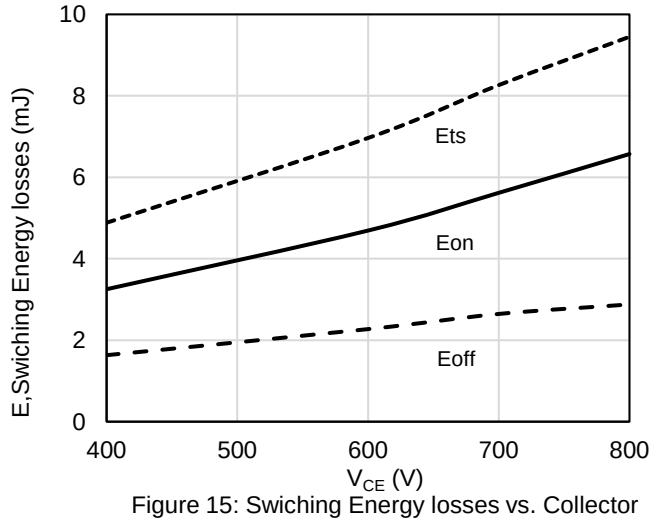


Figure 15: Swiching Energy losses vs. Collector Emitter Voltage

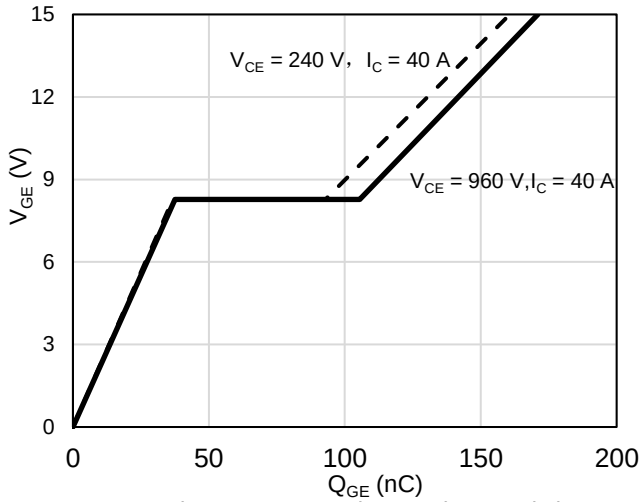


Figure 16: Gate-Charge Characteristics

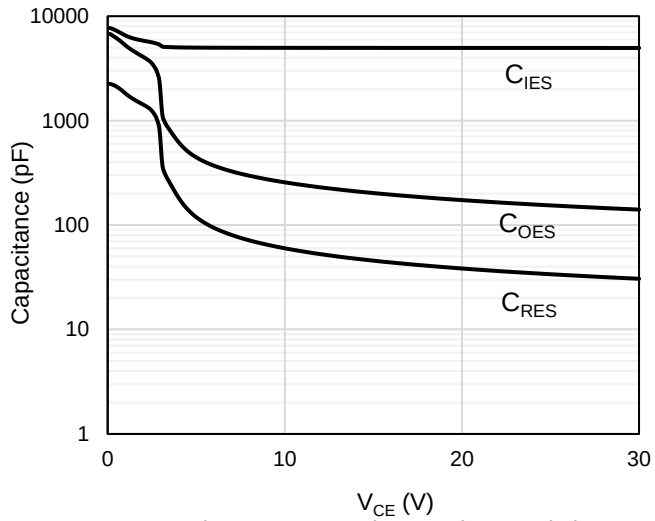


Figure 17: Capacitance Characteristics

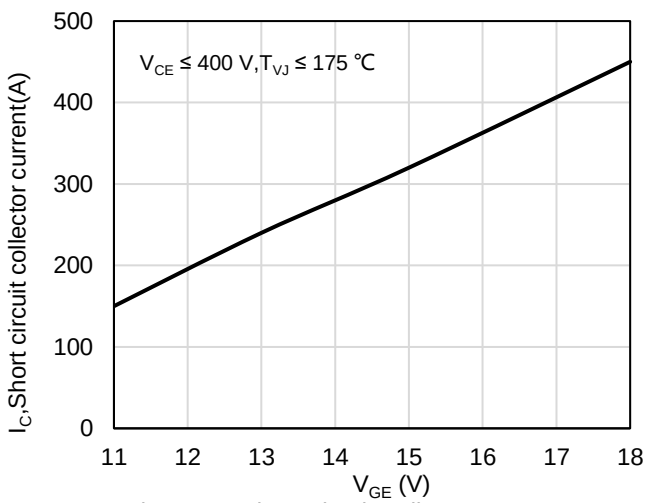


Figure 18: Short Circuit Collector Current vs. Gate Emitter Voltage

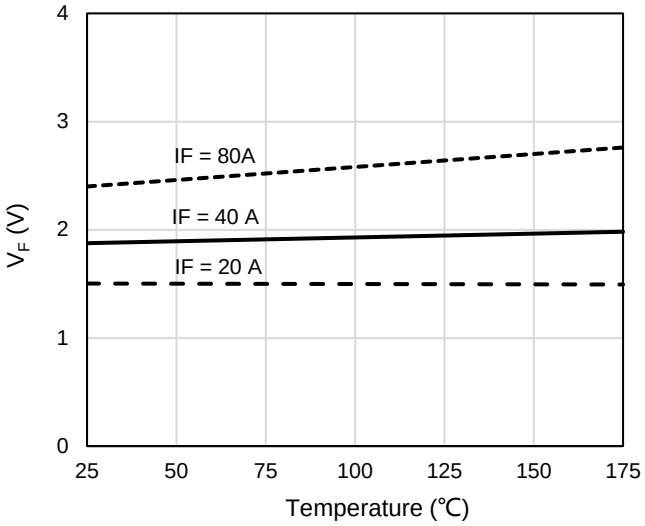


Figure 19: Diode Forward Voltage vs. Junction Temperature

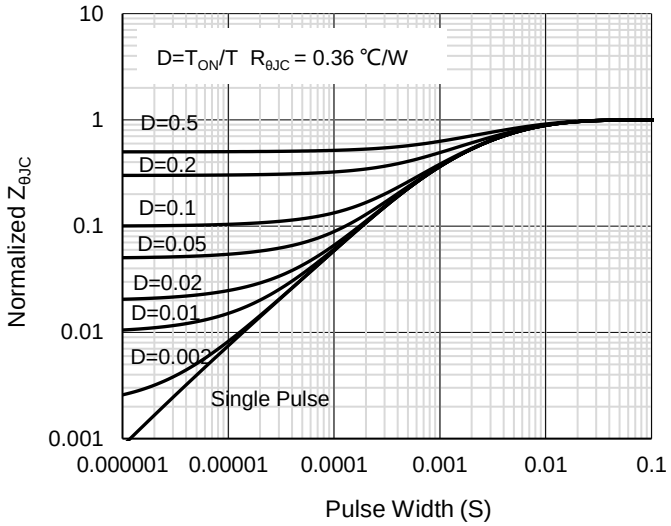


Figure 20: Normalized Maximum IGBT Transient Thermal Impedance

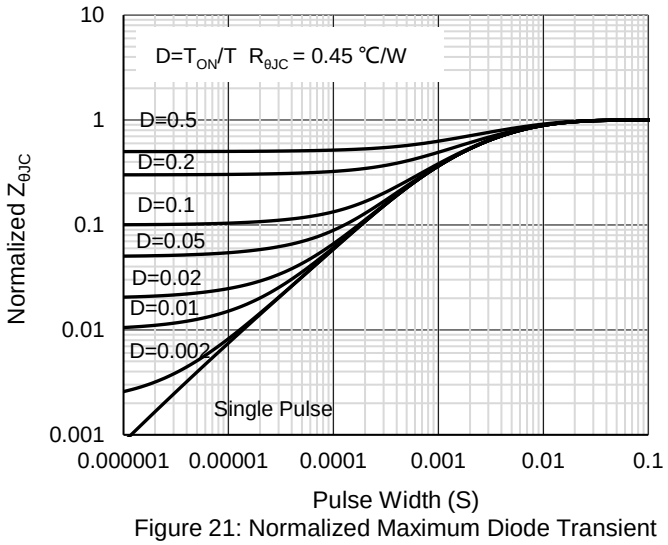


Figure 21: Normalized Maximum Diode Transient Thermal Impedance

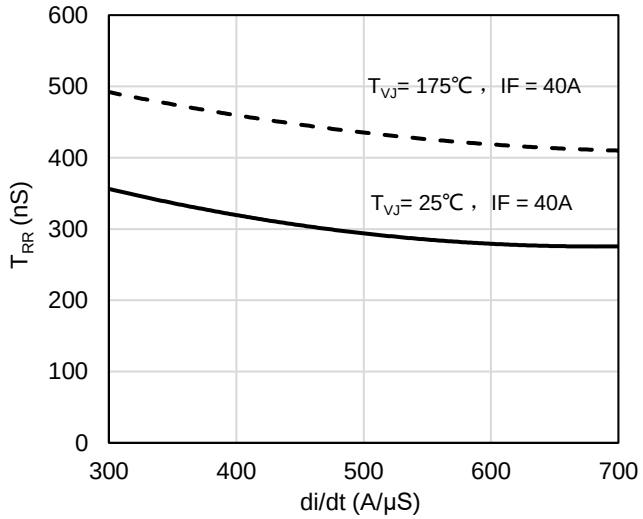


Figure 22: Reverse Recovery Time vs. Diode Current Slope

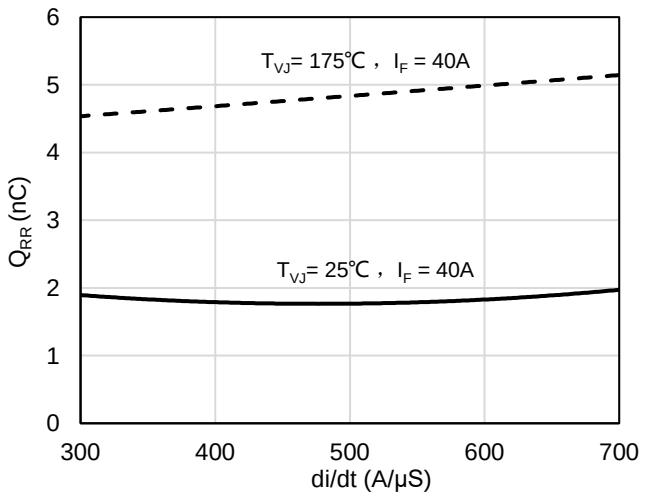


Figure 23: Reverse Recovery Charge vs. Diode Current Slope

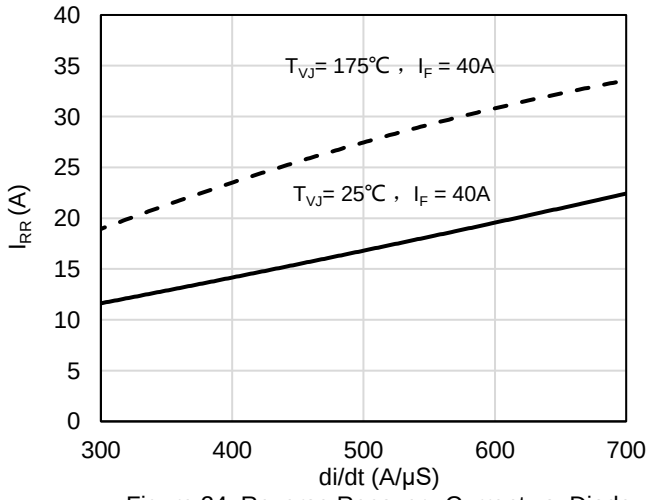


Figure 24: Reverse Recovery Current vs. Diode Current Slope

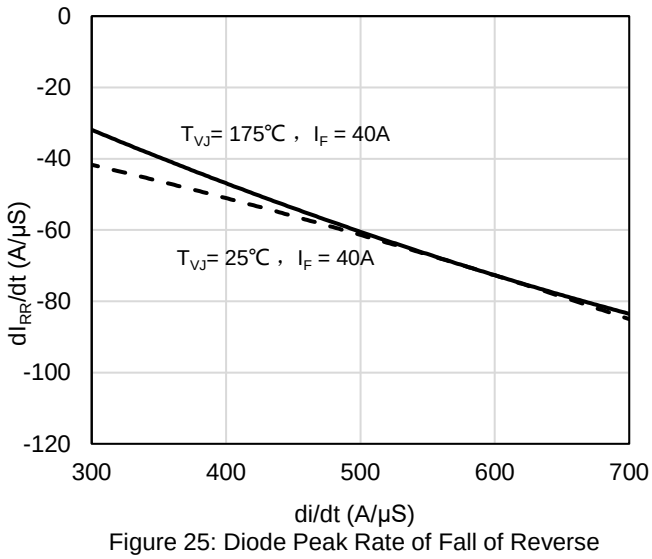
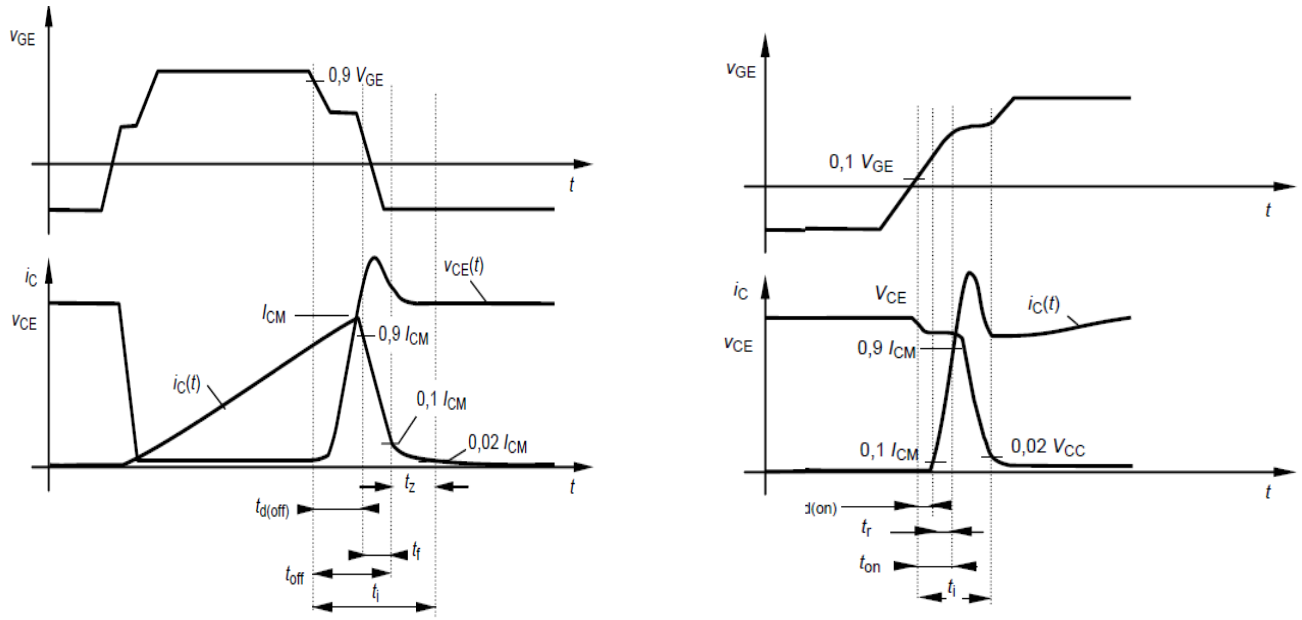


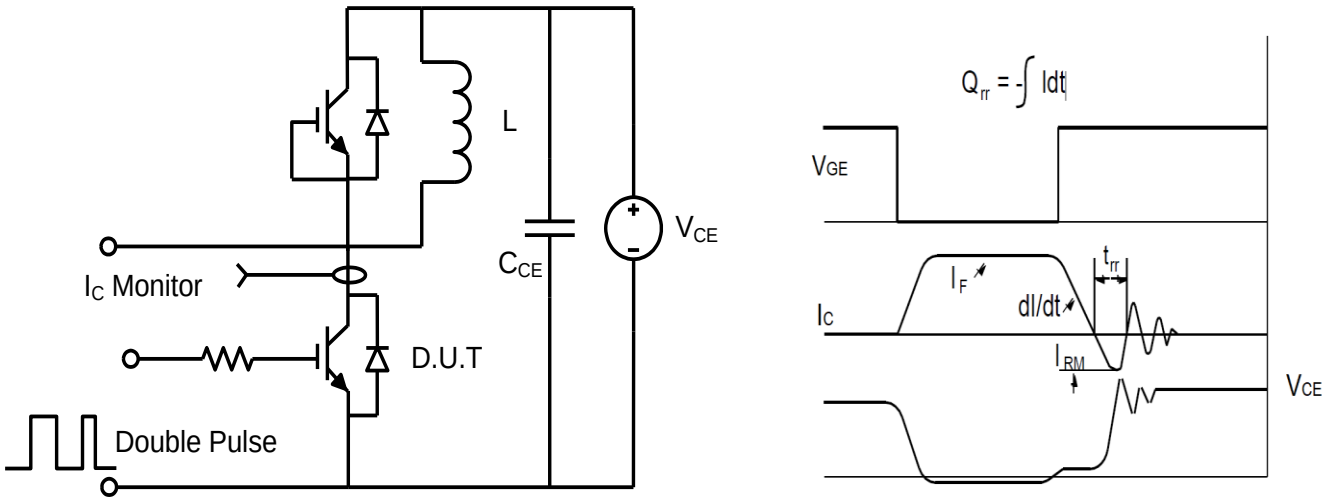
Figure 25: Diode Peak Rate of Fall of Reverse Recovery Current vs. Diode Current Slope

Test Circuit and Waveform

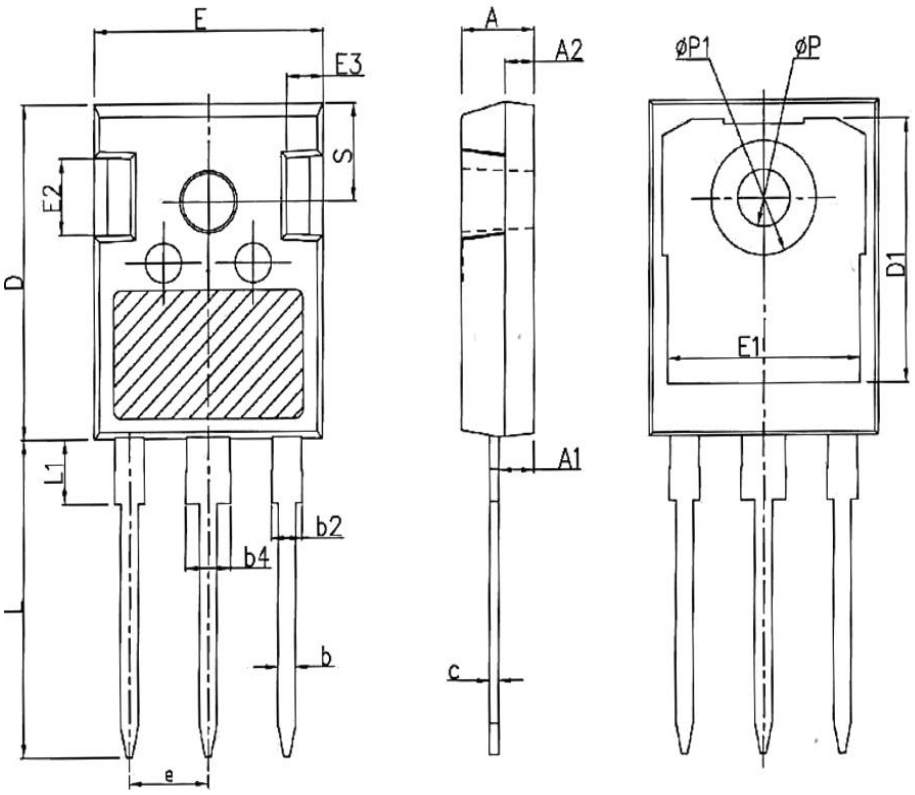
Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outlines



SYMBOL	mm		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		

Marking Information

Note:
BK2A040WHH = Product Name Code
XXXXXXX = Date code
Contact ALKAIDSEMI sales for detail information

Revision History

Revision	Release Date	Remark
Rev.1.1	2023/2/10	

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.